









## ATOMIC LAYER DEPOSITION (ALD)

### Effects of rapid thermal annealing on the properties of HfO<sub>2</sub>/La<sub>2</sub>O<sub>3</sub> nanolaminate films deposited by plasma enhanced atomic layer deposition

Duo Cao, Xinhong Cheng, Li Zheng, Zhongjian Wang, Dawei Xu, Chao Xia, Lingyan Shen, Qian Wang, Yuehui Yu and DaShen Shen

J. Vac. Sci. Technol. A **33**, 01A116 (2015); <http://dx.doi.org/10.1116/1.4900935>

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### Conductivity and touch-sensor application for atomic layer deposition ZnO and Al:ZnO on nylon nonwoven fiber mats

William J. Sweet III, Christopher J. Oldham and Gregory N. Parsons

J. Vac. Sci. Technol. A **33**, 01A117 (2015); <http://dx.doi.org/10.1116/1.4900718>

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### Role of the (Ta/Nb)O<sub>x</sub>/Al<sub>2</sub>O<sub>3</sub> interface on the flatband voltage shift for Al<sub>2</sub>O<sub>3</sub>/(Ta/Nb)O<sub>x</sub>/Al<sub>2</sub>O<sub>3</sub> multilayer charge trap capacitors

Toshihide Nabatame, Akihiko Ohi, Kazuhiro Ito, Makoto Takahashi and Toyohiro Chikyo

J. Vac. Sci. Technol. A **33**, 01A118 (2015); <http://dx.doi.org/10.1116/1.4901231>

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### Integration of molecular-layer-deposited aluminum alkoxide interlayers into inorganic nanolaminate barriers for encapsulation of organic electronics with improved stress resistance

Christoph Hossbach, Frederik Nehm, Aarti Singh, Hannes Klumbies, Dustin Fischer, Claudia Richter, Uwe Schroeder, Matthias Albert, Lars Müller-Meskamp, Karl Leo, Thomas Mikolajick and Johann W. Bartha

J. Vac. Sci. Technol. A **33**, 01A119 (2015); <http://dx.doi.org/10.1116/1.4901232>

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### Carbon-induced trapping levels in oxide dielectrics

Hiral D. Tailor, John L. Lyons, Minseok Choi, Anderson Janotti and Chris G. Van de Walle

J. Vac. Sci. Technol. A **33**, 01A120 (2015); <http://dx.doi.org/10.1116/1.4901234>

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### Studies on atomic layer deposition of IRMOF-8 thin films

Leo D. Salmi, Mikko J. Heikkilä, Marko Vehkamäki, Esa Puukilainen, Mikko Ritala and Timo Sajavaara

J. Vac. Sci. Technol. A **33**, 01A121 (2015); <http://dx.doi.org/10.1116/1.4901455>

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### Thin film analysis by low-energy ion scattering by use of TRBS simulations

Philipp Brüner, Thomas Grehl, Hidde Brongersma, Blanka Detlefs, Emmanuel Nolot, Helen Grampeix, Erich Steinbauer and Peter Bauer

J. Vac. Sci. Technol. A **33**, 01A122 (2015); <http://dx.doi.org/10.1116/1.4901451>





## ATOMIC LAYER DEPOSITION (ALD)

### **Improved thermal stability and electrical properties of atomic layer deposited HfO<sub>2</sub>/AlN high-k gate dielectric stacks on GaAs**

Yan-Qiang Cao, Xin Li, Lin Zhu, Zheng-Yi Cao, Di Wu and Ai-Dong Li

J. Vac. Sci. Technol. A **33**, 01A136 (2015); <http://dx.doi.org/10.1116/1.4903367>

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### **Designing high performance precursors for atomic layer deposition of silicon oxide**

Anupama Mallikarjunan, Haripin Chandra, Manchao Xiao, Xinjian Lei, Ronald M.

Pearlstein, Heather R. Bowen, Mark L. O'Neill, Agnes Derecskei-Kovacs and Bing Han

J. Vac. Sci. Technol. A **33**, 01A137 (2015); <http://dx.doi.org/10.1116/1.4903275>

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### **Enhancement of photoluminescence properties in ZnO/AlN bilayer heterostructures grown by atomic layer deposition**

Shang-Bin Zhu, Hong-Liang Lu, Qiu-Xiang Zhang, Yuan Zhang, Qing-Qing Sun, Peng

Zhou, Shi-Jin Ding and David Wei Zhang

J. Vac. Sci. Technol. A **33**, 01A138 (2015); <http://dx.doi.org/10.1116/1.4903935>

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### **Atomic layer deposition of aluminum sulfide thin films using trimethylaluminum and hydrogen sulfide**

Soumyadeep Sinha, Neha Mahuli and Shaibal K. Sarkar

J. Vac. Sci. Technol. A **33**, 01A139 (2015); <http://dx.doi.org/10.1116/1.4903951>

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### **Thermodynamics and kinetic behaviors of thickness-dependent crystallization in high-k thin films deposited by atomic layer deposition**

Xianglong Nie, Fei Ma, Dayan Ma and Kewei Xu

J. Vac. Sci. Technol. A **33**, 01A140 (2015); <http://dx.doi.org/10.1116/1.4903946>

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### **Undoped TiO<sub>2</sub> and nitrogen-doped TiO<sub>2</sub> thin films deposited by atomic layer deposition on planar and architected surfaces for photovoltaic applications**

Liang Tian, Adurey Soum-Glaude, Fabien Volpi, Luc Salvo, Grégory Berthomé, Stéphane

Coindeau, Arnaud Mantoux, Raphaël Boichot, Sabine Lay, Virginie Brizé, Elisabeth

Blanquet, Gaël Giusti and Daniel Bellet

J. Vac. Sci. Technol. A **33**, 01A141 (2015); <http://dx.doi.org/10.1116/1.4904025>

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### **Role of atomic layer deposited aluminum oxide as oxidation barrier for silicon based materials**

Giuseppe Fiorentino, Bruno Morana, Salvatore Forte and Pasqualina Maria Sarro

J. Vac. Sci. Technol. A **33**, 01A142 (2015); <http://dx.doi.org/10.1116/1.4904208>





